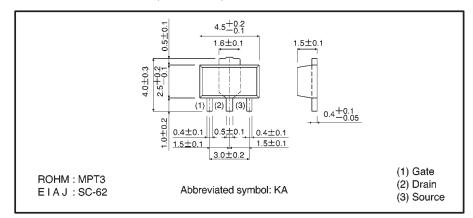
# Small switching (30V, 2A) 25K2103

### Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Wide SOA (safe operating area).
- 4) Low-voltage drive (4V).
- 5) Easily designed drive circuits.
- 6) Easy to use in parallel.

# ●Structure Silicon N-channel MOSFET

### External dimensions (Units: mm)



# ● Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		VDSS	30	V
Gate-source voltage		Vgss	±20	V
Drain current	Continuous	lo	2	А
	Pulsed	loe*1	8	Α
Reverse drain current	Continuous	lor	2	Α
	Pulsed	IDRP*1	8	Α
Total power dissipation		Po	0.5 2*2	W
Channel temperature		Tch	150	ပ
Storage temperature		Tstg	<b>−55∼+150</b>	$^{\circ}$

<sup>\*1</sup> Pw $\leq$ 10  $\mu$ s, Duty cycle $\leq$ 1% \*2 When mounted on a 40  $\times$  40  $\times$  0.7 mm alumina board.

# Packaging specifications

	Package	Taping
Type	Code	T100
	Basic ordering unit (pieces)	1000
2SK2103		0

Transistors 2SK2103

# ●Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Gate-source leakage	I <sub>GSS</sub>	_	_	±100	nA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V(BR) DSS	30	_	_	٧	ID=1mA, VGS=0V
Zero gate voltage drain current	loss	_	_	10	μΑ	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V
Gate threshold voltage	VGS (th)	1.0	_	2.5	٧	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA
Static drain-source on-state	RDS (on)	_	0.25	0.4	Ω	In=1A, Vgs=10V
resistance		_	0.38	0.6		In=1A, Vgs=4V
Forward transfer admittance	Y <sub>fs</sub>  *	1.0	_	_	S	I <sub>D</sub> =1A, V <sub>DS</sub> =10V
Input capacitance	Ciss	_	230	_	pF	V <sub>DS</sub> =10V
Output capacitance	Coss	_	120	_	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	_	60	_	pF	f=1MHz
Turn-on delay time	td (on)	_	10	_	ns	I <sub>D</sub> =1A, V <sub>DD</sub> ≒15V
Rise time	tr	_	25	_	ns	V <sub>GS</sub> =10V
Turn-off delay time	td (off)	_	60	_	ns	R <sub>L</sub> =15Ω
Fall time	tr	_	60	_	ns	R <sub>G</sub> =10Ω
Reverse recovery time	trr	_	70		ns	IDR=2A, VGS=0V, di/dt=50A/ $\mu$ S

<sup>\*</sup> Pw $\leq$ 300  $\mu$ s, Duty cycle $\leq$ 1%

### Electrical characteristic curves

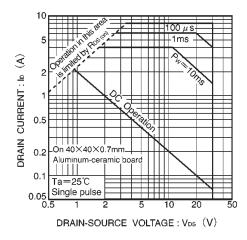


Fig.1 Maximum safe operating area

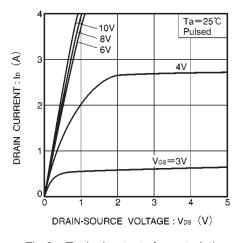


Fig.2 Typical output characteristics

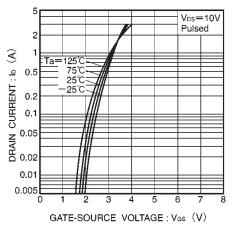
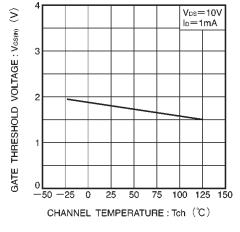
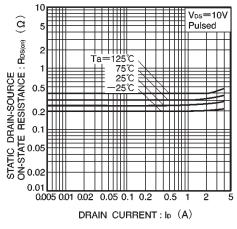


Fig.3 Typical transfer characteristics

Transistors 2SK2103





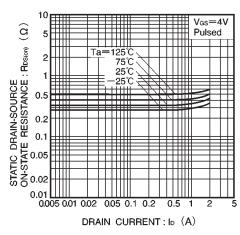
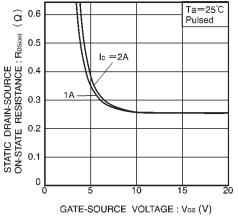


Fig.4 Gate threshold voltage vs. channel temperature

Fig.5 Static drain-source on-state resistance vs. drain current (I)

Fig.6 Static drain-source on-state resistance vs. drain current ( I )



0.8 V<sub>GS</sub>=10V **Q** ln=1A 0.7 Pulsed : Ros<sub>(on)</sub> 0.6 STATIC DRAIN-SOURCE ON-STATE RESISTANCE 0.5 0.4 0.3 0.2 0.1 -25 50 75 100 125 25 CHANNEL TEMPERATURE: Tch (℃)

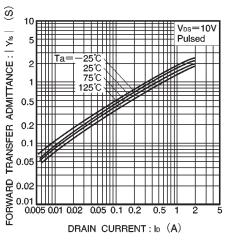
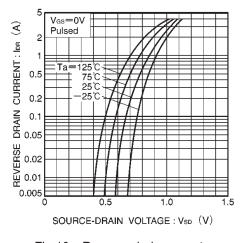


Fig.7 Static drain-source on-state resistance vs. gate-source voltage

Fig.8 Static drain-source on-state resistance vs. channel temperature

Fig.9 Forward transfer admittance vs. drain current



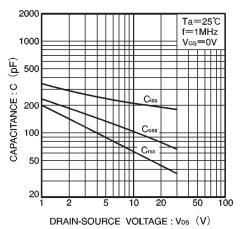


Fig.10 Reverse drain current vs. source-drain voltage ( I )

Fig.11 Reverse drain current vs. source-drain voltage ( II )

Fig.12 Typical capacitance vs. drain-source voltage

**Transistors** 2SK2103

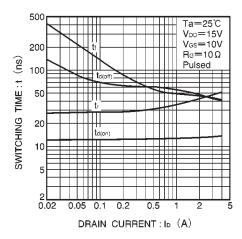


Fig.13 Switching characteristics (See Figurse 15 and 16 for the measurement circuit and resultant waveforms)

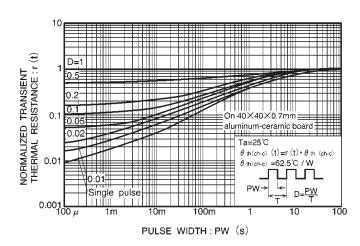


Fig.14 Normalized transient thermal resistance vs. pulse width

Switching characteristics measurement circuit

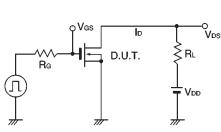


Fig.15 Switching time measurement circuit



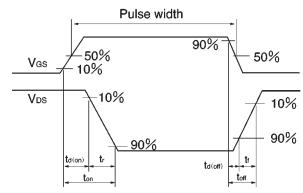


Fig.16 Switching time waveforms

### Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any
  means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the
  product described in this document are for reference only. Upon actual use, therefore, please request
  that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or
  otherwise dispose of the same, no express or implied right or license to practice or commercially
  exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document use silicon as a basic material.
   Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

About Export Control Order in Japan

Products described herein are the objects of controlled goods in Annex 1 (Item 16) of Export Trade Control Order in Japan.

In case of export from Japan, please confirm if it applies to "objective" criteria or an "informed" (by MITI clause) on the basis of "catch all controls for Non-Proliferation of Weapons of Mass Destruction.

ROHM

Appendix1-Rev1.0